

TITLE

BINDER DIFFUSION TRANSFER PATTERNING OF A THICK FILM  
PASTE LAYER

ABSTRACT

5           The present invention concerns a process for the fabrication of  
electrical and electronic devices. A polymer film is patterned on a  
substrate. A thick film paste is deposited over the patterned polymer. The  
thick film paste is dried under conditions which allow diffusion of the  
polymer into the thick film paste. This renders the diffused area insoluble  
10 in alkaline development solution.

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BCS/dmm